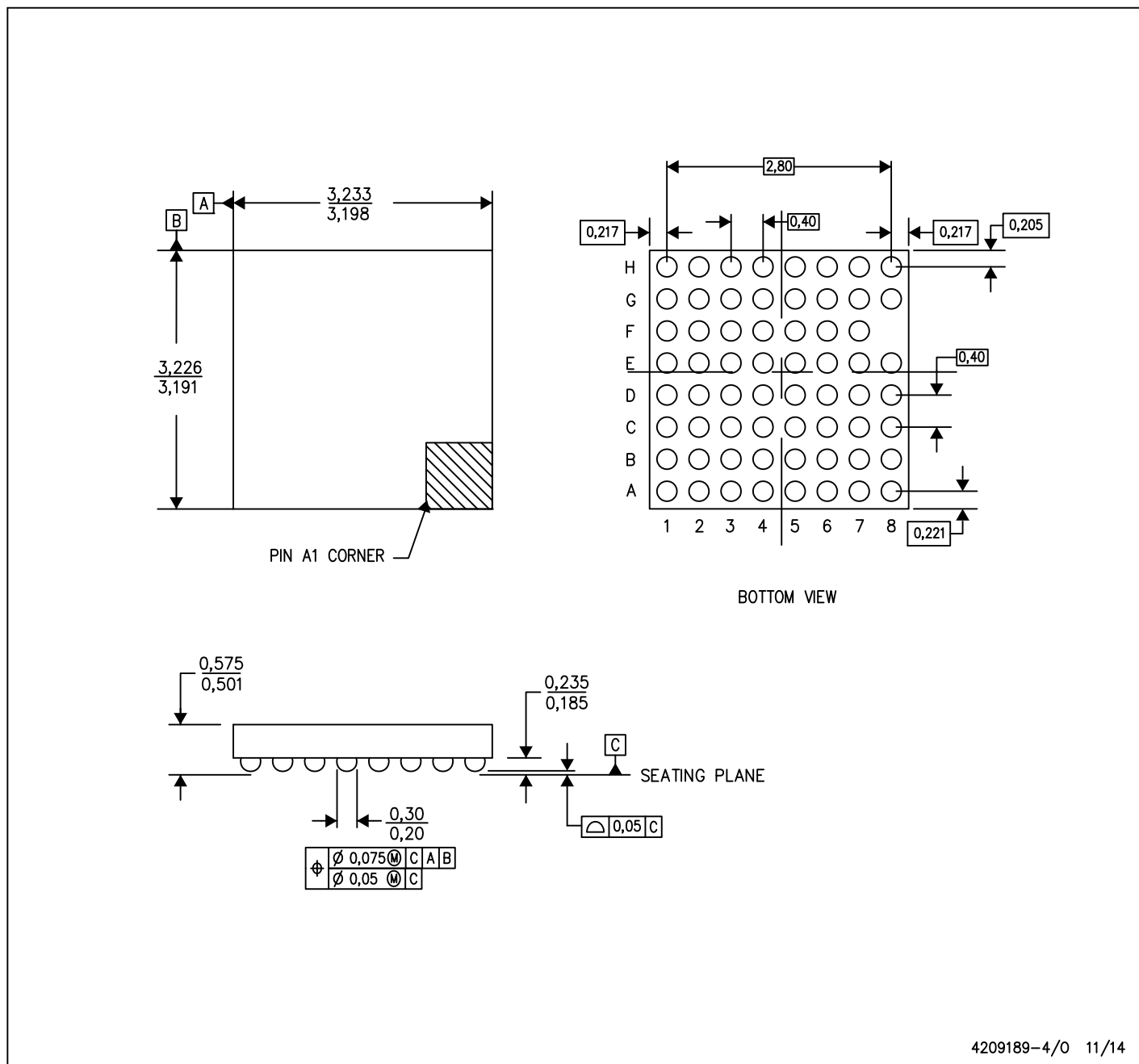


YFV (R-XBGA-N63)

DIE-SIZE BALL GRID ARRAY (WCSP)



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. NanoFree™ package configuration.
  - D. This package contains Pb-free balls.

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